HASP 2016 Student Payload Monthly Report

Payload Flight Number:				Institution:							
20016-09				University of Central Florida							
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Payload Title:											
Hazardous Gases for Harsh Environments LED Sensor											
Student Leader:				Faculty Advisor:							
Michael Villar (Graduate Student)				Dr. Subith Vasu							
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Current Team Members:											
Justin Urso (Graduate Student)Akshita Parupalli (Undergraduate Student)								lent)			
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Past Team Members:											
Kyle Thurmond (Graduate Student)											
Machanical and Aerospace Engineering											
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Keport Month:				sizzionic							
May				5/27/2016							
Gantt Chart:											
	ĺ		May			June					
Tasks	5/1/2016	5/8/2016	5/15/2016	5/22/2016	5/29/2016	6/5/2016	6/12/2016	6/19/2016	6/26/2016		
DAQ Programing (K,M)	x	Х									
Environmental Chamber Testing 2 (M,A)			X	Х	×	×					
HASP Chassis Construction (M,A)					X	x	x	x	x		
HASP Electronics Readiness (M,A)							х	х	Х		
Corrective Actions (M,A)		Х									
HASP ST&P Measurements (M,A)											
HASE LIBIT (IAPA)	Į		ļ						⊢ I		
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Team Member Activities:

Kyle Thurmond has since graduated UCF and as such has been moved to the Past Members list. He is still available for consultation if the need arises.

Michael Villar worked primarily with Akshita Parupalli with optimizing wiring and system layout for a second round of Environmental Chamber Testing. As well as creating detailed wiring schematics of current system layout for ease of modification. Prep work has also begun on finalizing wiring organizational layout for the HASP flight chassis as well as reinforcing solder connection joints and shortening excess wires.

Akshita Parupalli has continued on the test cell redesign. The cells dimensions and geometries have been finalized and a detailed materials analysis is being done to select the optimal test cell composition. Current favored choice is to make the cell out of PVC. Different polyethylene compositions for the diaphragm are also being tested in the EC to determine the most resistant material.

Justin Urso's focus has been on an outside research project and was mainly available for consultation and environmental chamber testing assistance.

Issues Encountered:

- Update: New Electronics modifications for LED temperature control
 - Imbedded TEC in the LED housing only operates in a single direction, waiting on response from manufacturing company to confirm. If correct an additional TEC will be added to the back of the LED casing to enable heating to resolve the problem.
- Update: Continual modifications to the Payload chassis
 - A second round of environmental chamber tests are underway so temporary support structure is still in use. The final flight payload chassis is being prepped upon completion of EC testing.

Milestones Achieved:

- Secondary Environmental Chamber testing was completed.
 - Another round of Environmental Chamber tests are underway and set to be completed within the next few days. A few improvements on the previous rounds of testing should increase accuracy of collected data.
- cRIO DAQ VI improvements
 - Modifications to TEC relay internal VI timing has been optimized to improve responsiveness of solid state relays for TEC current switching.